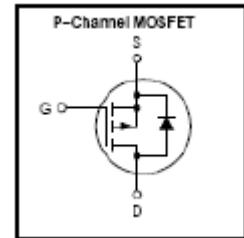


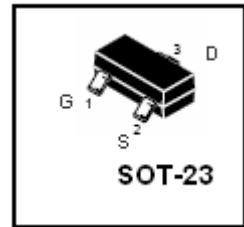
## Features

- -4.3A, -30V,  $R_{DS(on)}$ (Max 58mΩ)@ $V_{GS}=-4.5V$
- -2.5V Rated for Low Voltage Gate Drive
- SOT-23 Surface Mount for Small Footprint
- Single Pulse Avalanche Energy Rated



## General Description

This Power MOSFET is produced using Winsemi's advanced MOS technology. This latest technology has been especially designed to minimize on-state resistance, have a high rugged avalanche characteristics. This devices is specially well suited for Load/Power Management for Portables and Computing, Charging Circuits and Battery Protection



## Absolute Maximum Ratings( $T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter		Value	Units
$V_{DSS}$	Drain Source Voltage		-30	V
$V_{GSS}$	Gate-to-Source Voltage		$\pm 12$	V
$I_D$	Continuous Drain Current		-4.3	A
$I_{DM}$	Drain Current Pulsed	PW≤10us,duty cycle≤1%	-25	A
$P_D$	Allowable Power Dissipation	Mounted on a ceramic board (1000mm <sup>2</sup> × 0.8mm) lunit	0.25	W
$P_T$	Total Dissipation	Mounted on a ceramic board (1000mm <sup>2</sup> × 0.8mm)	0.3	
$T_{ch}$	Channel Temperature		150	°C
$T_{stg}$	Storage Temperature		-55~150	°C

**Electrical Characteristics ( $T_c = 25^\circ C$ )**

Characteristics	Symbol	Test Condition	Min	Type	Max	Unit	
Gate leakage current(Note 4)	$I_{GS}$	$V_{GS} = \pm 12 V, V_{DS} = 0 V$	-	-	$\pm 100$	nA	
Drain cut-off current(Note 4)	$I_{DSS}$	$V_{DS} = -30 V, V_{GS} = 0 V$	-	-	-1	$\mu A$	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = -250 \mu A, V_{GS} = 0 V$	-30	-	-	V	
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.6	-1.0	-1.3	V	
Drain-source ON resistance	$R_{DS(ON)}$	$V_{GS} = -4.5 V, I_D = -3.5 A$	-	52	58	$m\Omega$	
		$V_{GS} = -2.5 V, I_D = -2.5 A$		72	80		
Input capacitance	$C_{iss}$	$V_{DS} = -15 V,$	-	933	1200	$pF$	
Reverse transfer capacitance	$C_{rss}$	$V_{GS} = 0 V,$	-	81	-		
Output capacitance	$C_{oss}$	$f = 1 MHz$	-	108	-		
Switching time (Note 5)	Turn-on Delay time	$t_{d(on)}$	$V_{GS} = 10 V,$	-	5.2	-	$ns$
	Rise time	$t_r$	$V_{DS} = -15 V,$	-	6.8	-	
	Turn-off Delay time	$t_{d(off)}$	$R_G = 6 \Omega,$	-	42	-	
	Turn-off Fall time	$t_f$	$R_L = 3.5 \Omega$	-	15	-	
Total gate charge	$Q_g$	$V_{GS} = -4.5 V,$	-	9.3	12.2	$nC$	
Gate-source charge	$Q_{gs}$	$V_{DS} = -15 V,$	-	1.5	-		
Gate-drain ("miller") Charge	$Q_{gd}$	$I_D = -4.3 A$	-	3.7	-		
Diode Forward Voltage	$V_{SD}$	$I_S = -1, V_{GS}=0V$		-0.75	-1.0	V	

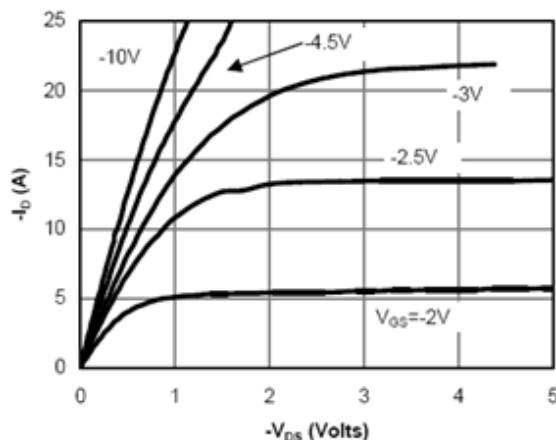


Figure 1: On-Region Characteristics

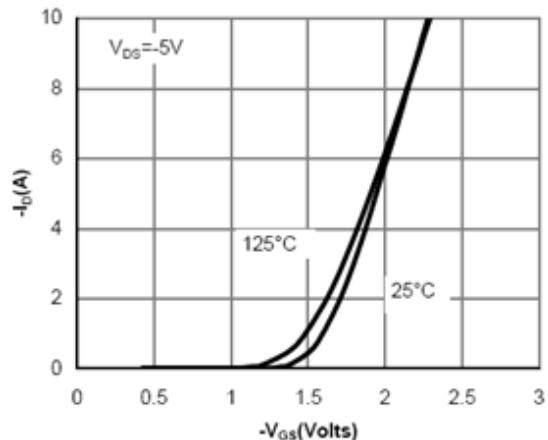


Figure 2: Transfer Characteristics

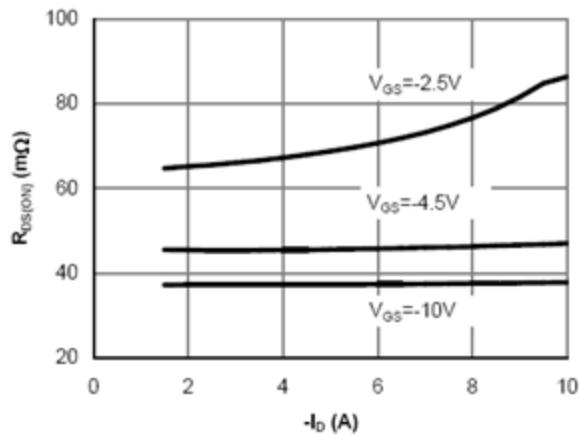


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

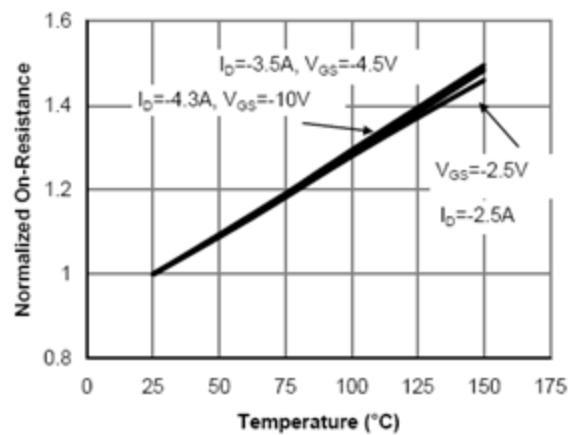


Figure 4: On-Resistance vs. Junction Temperature

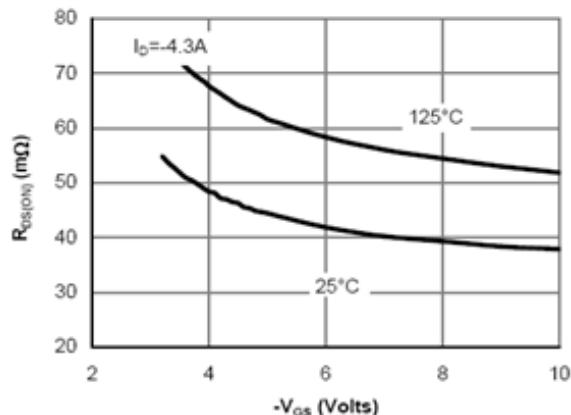


Figure 5: On-Resistance vs. Gate-Source Voltage

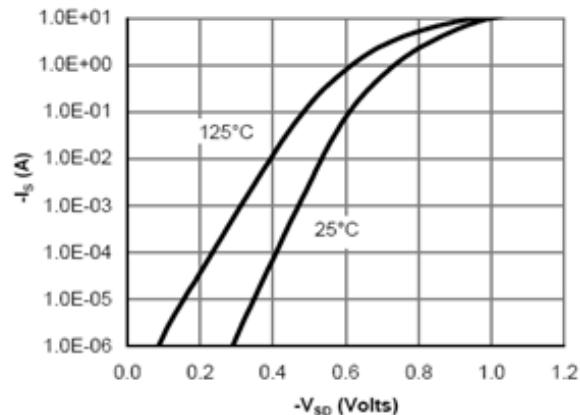
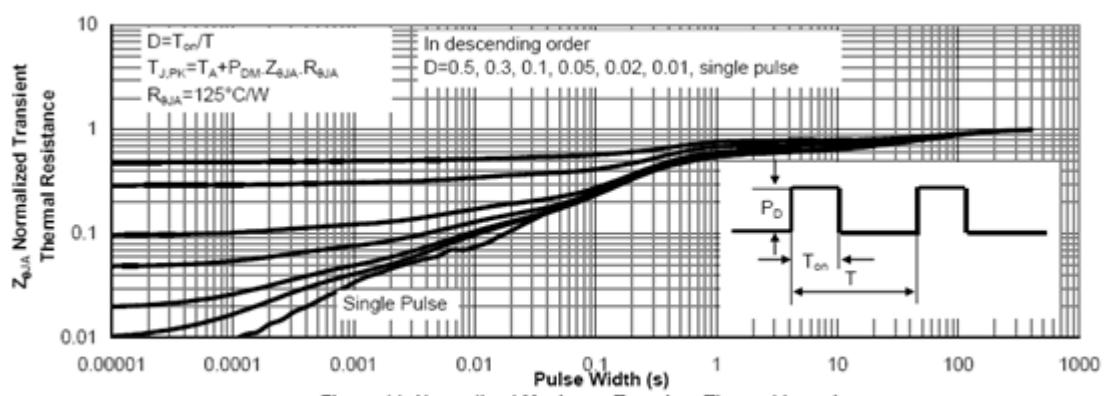
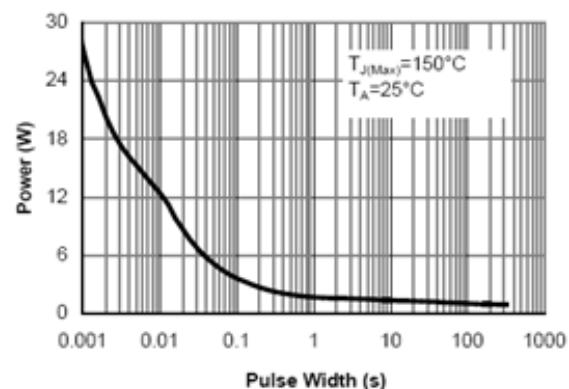
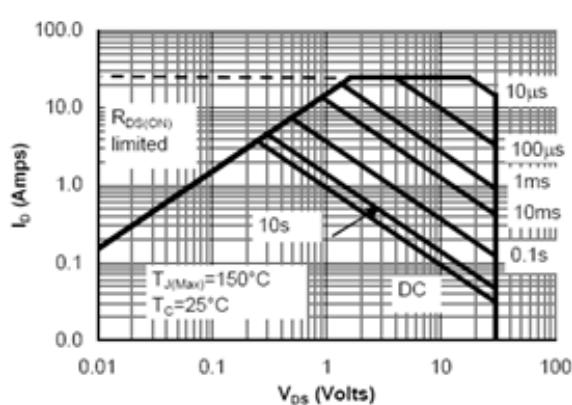
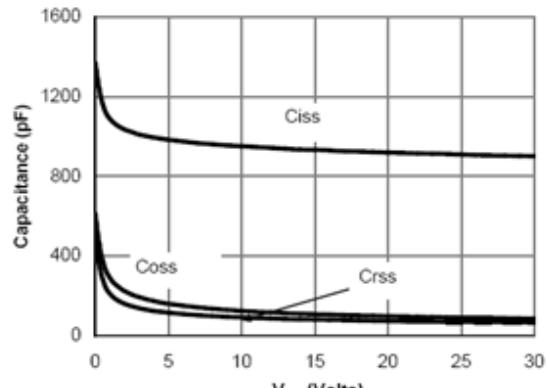
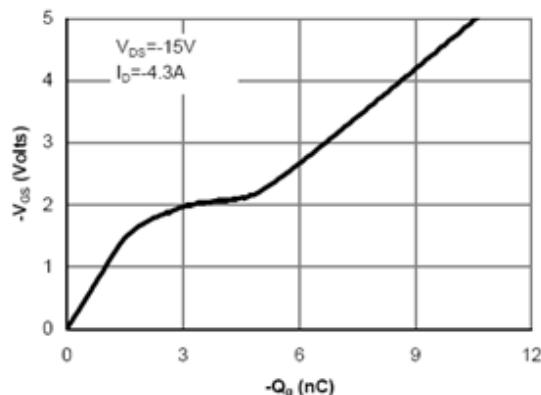


Figure 6: Body-Diode Characteristics



**SOT-23 Package Dimension**

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.95		0.037	
A1	1.90		0.074	
B	2.60	3.00	0.102	0.118
C	1.40	1.70	0.055	0.067
D	2.80	3.10	0.110	0.122
E	1.00	1.30	0.039	0.051
F	0.00	0.10	0.000	0.004
G	0.35	0.50	0.014	0.020
H	0.10	0.20	0.004	0.008
I	0.30	0.60	0.012	0.024
J	50°	10°	50°	10°

